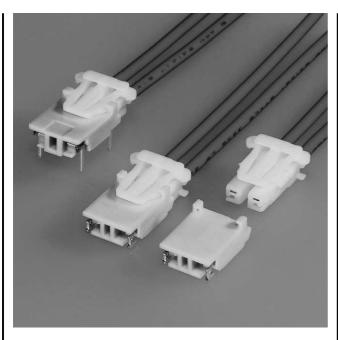


Disconnectable Crimp style connectors



Board-to-wire connector with high withstanding voltage, used for power supply of LCD (Liquid Crystal Display) back light.

Features -

• Secure locking mechanism

Arm-locking mechanism as secure lock is adopted in order to prevent coming out housing.

· High withstand voltage design

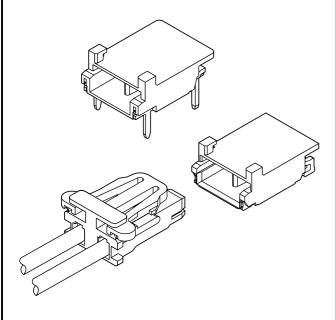
Securing the sufficient creepage distance, it considers as high withstanding voltage design. (Conformed to IEC-60950) When applying voltage rating, consideration of PC board pattern design is required.

Low profile

Corresponding to thinner LCD, the connector height is designed as small and low profile.

Compatibility

This BD connector is compatible BHS connector. Secure locking mechanism is available for BD connector header and socket only. Socket contact is same contact as BHS connector.



Specifications -

Current rating: 1.0A AC, DC (AWG #24)Voltage rating: 1,400V AC, DC

• Temperature range: -25°C to +85°C

(including temperature rise in applying

electrical current)

• Contact resistance: Initial value/10m Ω max.

After environmental testing/20m Ω max.

• Insulation resistance: 1,000M Ω min.

• Withstanding voltage: 3,800V AC/minute (50 to 60 Hz)

Applicable wire: AWG #28 to #24

* Contact JST if Lead-Free product is required.

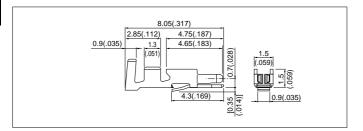
* Refer to "General Instruction and Notice when using Terminals and Connectors" at the end of this catalog.

* Contact JST for details.

Standards -

Recognized E60389

Contact -



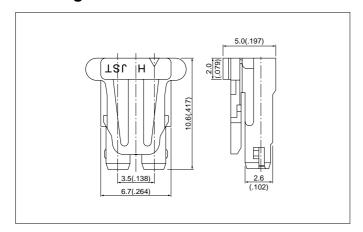
Model No.	Applicable wire		Insulation	Q'ty / reel	
Model No.	mm ²	AWG#	O.D. mm(in.)	Q ty / leel	
SBHS-002T-P0.5A	0.08 to 0.22	28 to 24	0.9 to 1.7(.035 to .067)	10,000	

Material and Finish

Phosphor bronze, tin-plated

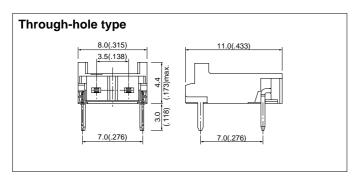
Note: Contact JST for SBHS-002T-P0.5.

Housing -

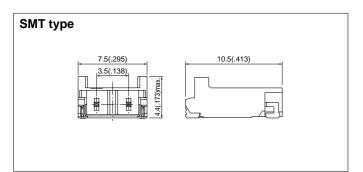


Circuits	Circuits Model No.			
2	BDMR-02VS-1	1,000		
Material				
	Nylon 66, UL94V-0, natural (white)			

Header -



Circuits	Circuits Model No.		
2	S02-BDS-3-TB	1,000	
Material and Finish			
Press pin: Brass, Copper-undercoated, tin-plated Wafer: Heat resisting resin, UL94V-0, natural (ivory) Solder tab: Brass, Copper-undercoated, tin-plated			

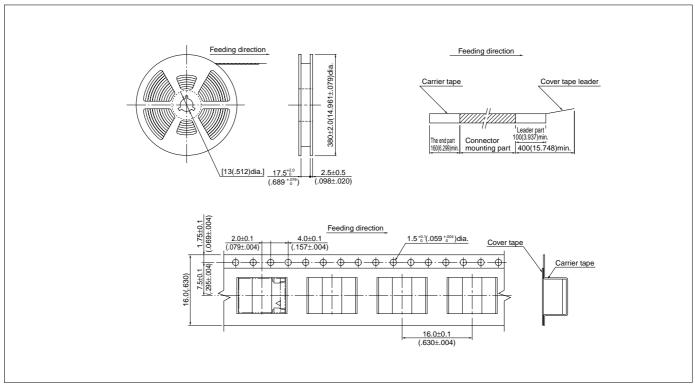


Circuits	Model No.	Q'ty / reel	
2	SM02-BDS-3-TB	1,000	
Material and Finish			
Posts Posses initial and assessed the forman and the standard			

Post: Brass, nickel-undercoated, tin/copper alloy-plated Wafer: Heat resisting resin, UL94V-0, natural (ivory) Solder tab: Brass, nickel-undercoated, tin/copper alloy-plated

Note: The product listed above is supplied on embossed tape.

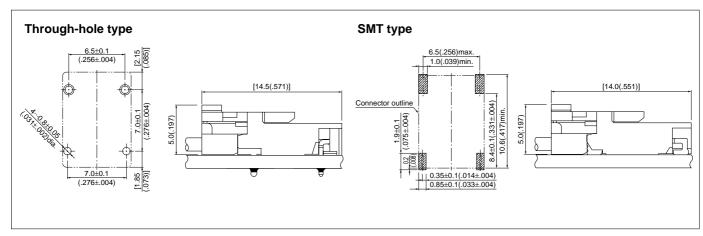
Taping specifications



Note

- 1. Specifications conform to JIS C 0806. The tape width, connector loading recess square hole dimensions, etc. are determined by the number of circuits and external shape of the connector to be loaded.
- 2. Specifications are subject to change without prior notice.

PC board layout (viewed from component side) and Assembly layout-



Applicator for the semi-automatic press AP-K2N -

Contact	Crimp applicator MKS-L		Compact crimp applicator MKS-LS		Strip-crimp applicator MKS-SC	
Contact	with safety cover	without safety cover	with safety cover	without safety cover	with safety cover	
SBHS-002T-P0.5A	APLMK SBHS002-05	APLNC SBHS002-05	_	_	_	